



SPECIFICATION

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SPEC. NO.: PS-51734-0750P-XXX REVISION: 0

PRODUCT NAME: PCI Express M.2 CONNECTOR

PRODUCT NO: 51734 , 51746 SERIES

PREPARED: IH.LEE DATE: 2014/11/20	CHECKED: ALEX DATE: 2014/11/20	APPROVED: SEAN DATE: 2014/11/20
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RELEASE DATE: 2014.11.20

REVISION: 0

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1 Revision History

Rev.	ECN #	Revision Description	Prepared	Date
1	ECN-1211019	PROPOSAL	IH. LEE	2012/11/15
2	ECN-1303182	ADD DESCRIPTION AND CORRECT	IH. LEE	2013/03/13
3	ECN-1306003	CORRECT THE TEST SEQUENCE	IH. LEE	2013/06/05
4	ECN-1308101	ADD 51733 SERIES	ALEX CHEN	2013/08/28
5	ECN-1307367	ADD 51746 SERIES	IH. LEE	2013/09/16
6	ECN-1311457	ADD 51736 SERIES AND MODULE CARD UNMATE OPERATION	IH. LEE	2013/12/06
7	ECN-1402149	<ol style="list-style-type: none"> 1. ADD 51747 SERIES. 2. ADD "Working V less than 36V" IN REQUIREMENTS DESCRIPTION. 3. ADD MODULE CARD OPERATE DESCRIPTION. 4. ADD RECOMMEND MODULE CARD DESCRIPTION. 	IH.LEE	2014/02/18
O	ECN-1411351	<ol style="list-style-type: none"> 1. DELETE 51733 51736 51747 SERIES 2. CHANGE THE DURABILITY CYCLES TO 60 CYCLES 	IH.LEE	2014/11/20

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2 SCOPE

This specification covers performance, tests and quality requirements for **PCI Express M.2 Connector**

3 APPLICABLE DOCUMENTS

EIA-364: ELECTRONICS INDUSTRIES ASSOCIATION

4 REQUIREMENTS

4.1 Design and Construction

- 4.1.1 Product shall be of design, construction and physical dimensions specified on applicable product drawing.
- 4.1.2 All materials conform to R.o.H.S. and the standard depends on TQ-WI-140101.

4.2 Materials and Finish

- 4.2.1 Contact: High performance copper alloy (**Phosphor Bronze**)
Finish:
 - (a) Contact Area: **Refer to the drawing.**
 - (b) Under plate: **Refer to the drawing.**
 - (c) Solder area: **Refer to the drawing.**
- 4.2.2 Housing: Thermoplastic or Thermoplastic High Temp., UL94V-0
- 4.2.3 Hold Down: High performance copper alloy(**Phosphor Bronze**)
Finish:
 - (a) Under plate: **Refer to the drawing.**
 - (b) Solder area: **Refer to the drawing.**

4.3 Ratings

- 4.3.1 Working Voltage Less than **36 Volts AC (per pin)**
- 4.3.2 Voltage: **50 Volts AC (per pin)**
- 4.3.3 Current: **0.5 Amperes (per pin)**
- 4.3.4 Operating Temperature : **-40°C to +80°C**

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5 Performance

5.1. Test Requirements and Procedures Summary

Item	Requirement	Standard
Examination of Product	Product shall meet requirements of applicable product drawing and specification.	Visual, dimensional and functional per applicable quality inspection plan.
ELECTRICAL		
Item	Requirement	Standard
Low Level Contact Resistance	Initial: 55 mΩ Max. per contact After test: 20 mΩ Max. change allowed	Mate connectors, measure by dry circuit, 20mV Max., 100mA Max. (EIA-364-23)
Insulation Resistance	500 MΩ Min.	Unmated connectors, apply 500 V DC between adjacent terminals. (EIA-364-21)
Dielectric Withstanding Voltage	No discharge, flashover or breakdown. Current leakage: 1 mA max.	300 V AC Min. at sea level for 1 minute. Test between adjacent contacts of unmated connectors. (EIA-364-20)
Temperature Rise	30°C Max. Change allowed	Mate connectors: measure the temperature rise at rated current until temperature stable. The ambient condition is still air at 25°C (EIA-364-70,Method2)

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MECHANICAL		
Item	Requirement	Standard
Durability	60 Cycles	The sample should be mounted in the tester and fully mated and unmated the number of cycles. (EIA-364-09)
Durability(precondition)	Perform 5 mate/unmate cycles if the application requires up to 25 over the life of the connector.20 cycles if the application requires 26~200;or,50 cycles if the application requires 201 or greater.	No evidence of physical damage (EIA-364-09)
Mating Forces	Mating Force: 2.55 Kgf Max.	Measure the force required to mate/unmate connector. (EIA-364-13 Method A)
Vibration	1 microsecond Max.	15 minutes in each of 3mutually perpendicular directions. Both mating halves should be rigidly fixed so as not to contribute to the relative motion of one contact against another. The method of fixturing should be detailed in the test report. (EIA-364-28 Condition VII Condition letter D)
Shock (Mechanical)	1 microsecond Max.	Mate connectors to 250G(Ultra-book) and 285 G(Tablet) at 2 milliseconds half sine on all six axis.
Reseating	Appearance: No damage	Manually mated/unmated the connector or socket perform 3 cycles.

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ENVIRONMENTAL

Item	Requirement	Standard
Resistance to Reflow Soldering Heat	See Product Qualification and Test Sequence Group 11 (Lead Free)	Pre Heat : 150°C~180°C , 60~120sec. Heat : 230°C Min., 40sec Min. Peak Temp. : 260°C Max, 10sec Max.
Thermal Shock	See Product Qualification and Test Sequence Group 2	Mate module and subject to follow condition for 10 cycles. 1 cycles: -55 +0/-3 °C , 30 minutes. +85 +3/-0 °C , 30 minutes. (EIA-364-32, method A test condition I)
Cyclic Temperature & Humidity	See Product Qualification and Test Sequence Group 2	Cycle the connector or socket between 25°C ±3°C at 80±3% RH and 65°C ±3°C at 50%±3% RH . Ramp times should be 0.5hrs. and dwell times should be 1.0 hrs. Dwell times start when the temperature and humidity have stabilized within the specified levels. Perform 24 such cycles. (EIA-364-31, Method III)
Temperature Life	See Product Qualification and Test Sequence Group 1	Subject mated connectors to temperature life at 105°C for 120 hours . (EIA-364-17, method A)
Temperature Life (precondition)	No physical damage	Subject mated connectors to temperature life at 105°C for 72 hours . (EIA-364-17, method A)
Salt Spray (Only For Gold Plating)	See Product Qualification and Test Sequence Group 8	Subject mated connectors to 5% salt-solution concentration, 35°C (I) Gold flash for 8 hours (II) Gold plating 5 u" for 96 hours. (EIA-364-26)
Solder Ability	Tin plating: Solder able area shall have minimum of 95% solder coverage. Gold plating: Solder able area shall have minimum of 75% solder coverage	Add then into solder bath, Temperature at 245 ±5°C , for 4-5 sec. (EIA-364-52)
Hand Soldering Temperature Resistance	Appearance: No damage	T ≥ 350°C , 3sec at least.

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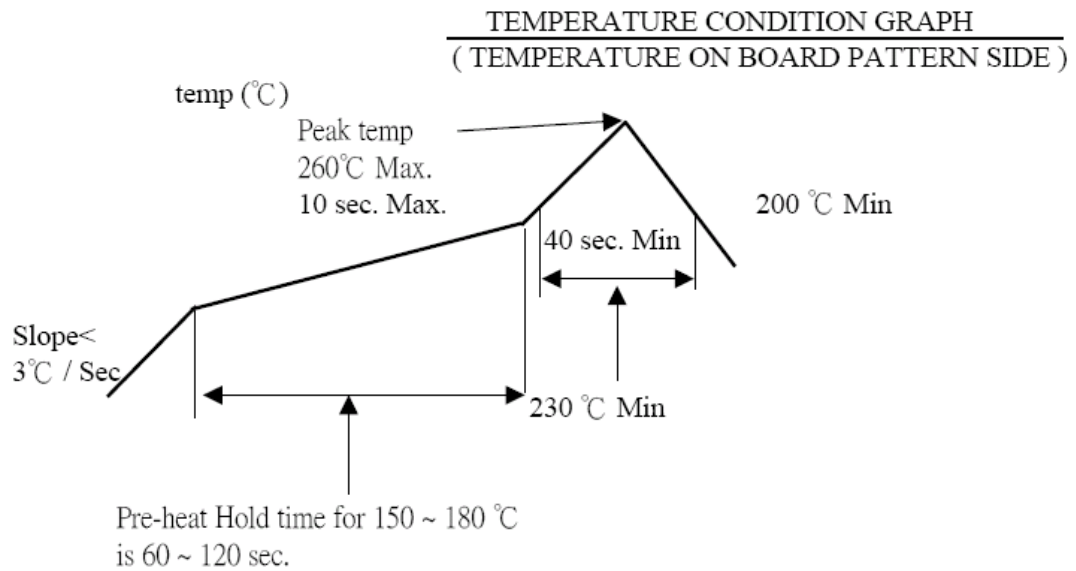
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ENVIRONMENTAL		
Item	Requirement	Standard
Thermal Disturbance	See Product Qualification and Test Sequence Group 10	Cycle the mated connector between $15^{\circ}\text{C}\pm 3^{\circ}\text{C}$ and $85^{\circ}\text{C}\pm 3^{\circ}\text{C}$, as measured on the part. Ramps should be a minimum of 2°C per minute, and dwell times should insure that the contacts reach the temperature extremes (a minimum of 5 minutes). Humidity is not controlled. Perform 10 such cycles.

Note. Flowing Mixed Gas shall be conducted by customer request.

6 INFRARED REFLOW CONDITION



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7 PRODUCT QUALIFICATION AND TEST SEQUENCE

Test or Examination	Test Group										
	1	2	3	4	5	6	7	8	9	10	11
	Test Sequence										
Examination of Product	1、6 9	1、6 9、12	1、6 9	1、7	1、4	1、3	1、7	1、5	1、3	1、5	1、3
Low Level Contact Resistance	2、5 8	2、5 8、11	2、5 8	2、6			2、4 6	2、4		2、4	
Insulation Resistance					2						
Dielectric Withstanding Voltage					3						
Mating / Unmating Forces				3、5							
Durability				4							
Durability(precondition)	3	3	3				3				
Temperature Rise						2					
Vibration			7								
Shock (Mechanical)							5				
Reseating	7	10									
Thermal Shock		4									
Cyclic Temperature & Humidity		7									
Temperature Life	4										
Temperature Life(precondition)			4								
Salt Spray								3			
Solder Ability									2		
Thermal Disturbance										3	
Resistance to Soldering Heat											2
Sample Size	4	4	4	4	4	4	4	4	4	4	4

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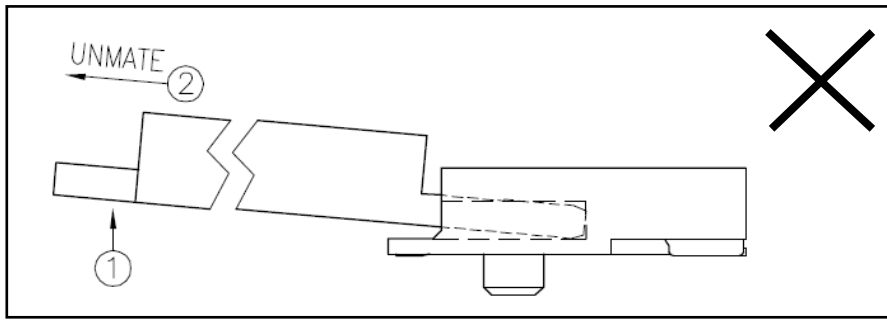
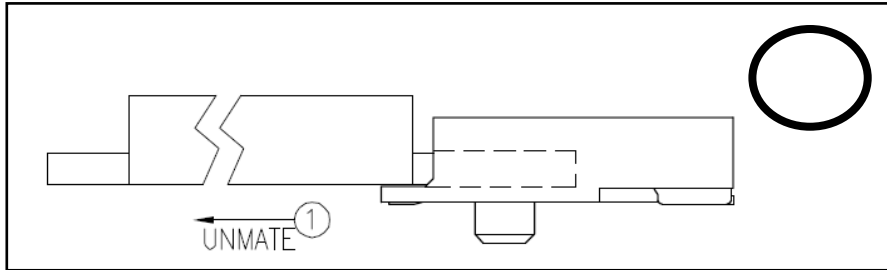
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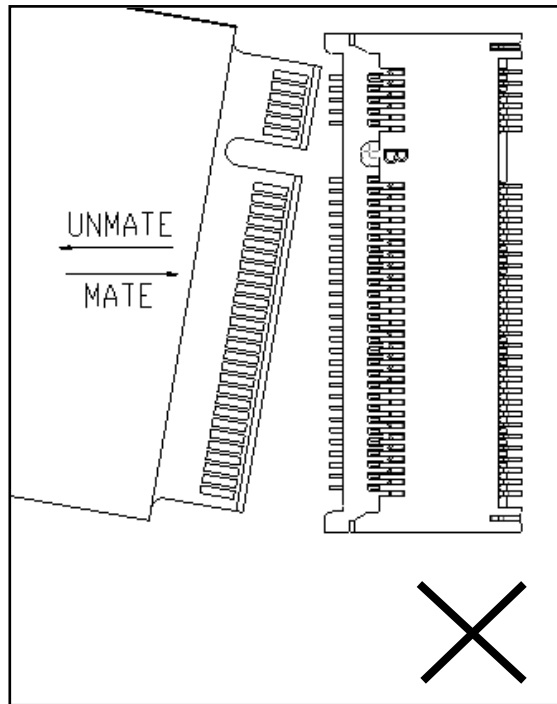
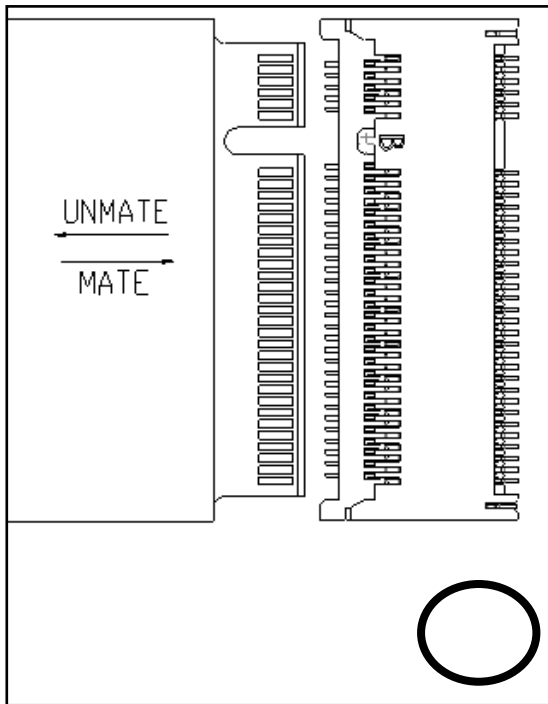
PAGE: **10** OF **12****8 MODULE CARD OPERATION**

Exercise care when handling connectors. Follow recommendations given below.

8-1 Prohibition with angles unmates the module card.



8-2 Prohibition with angles mate/unmates the module card.



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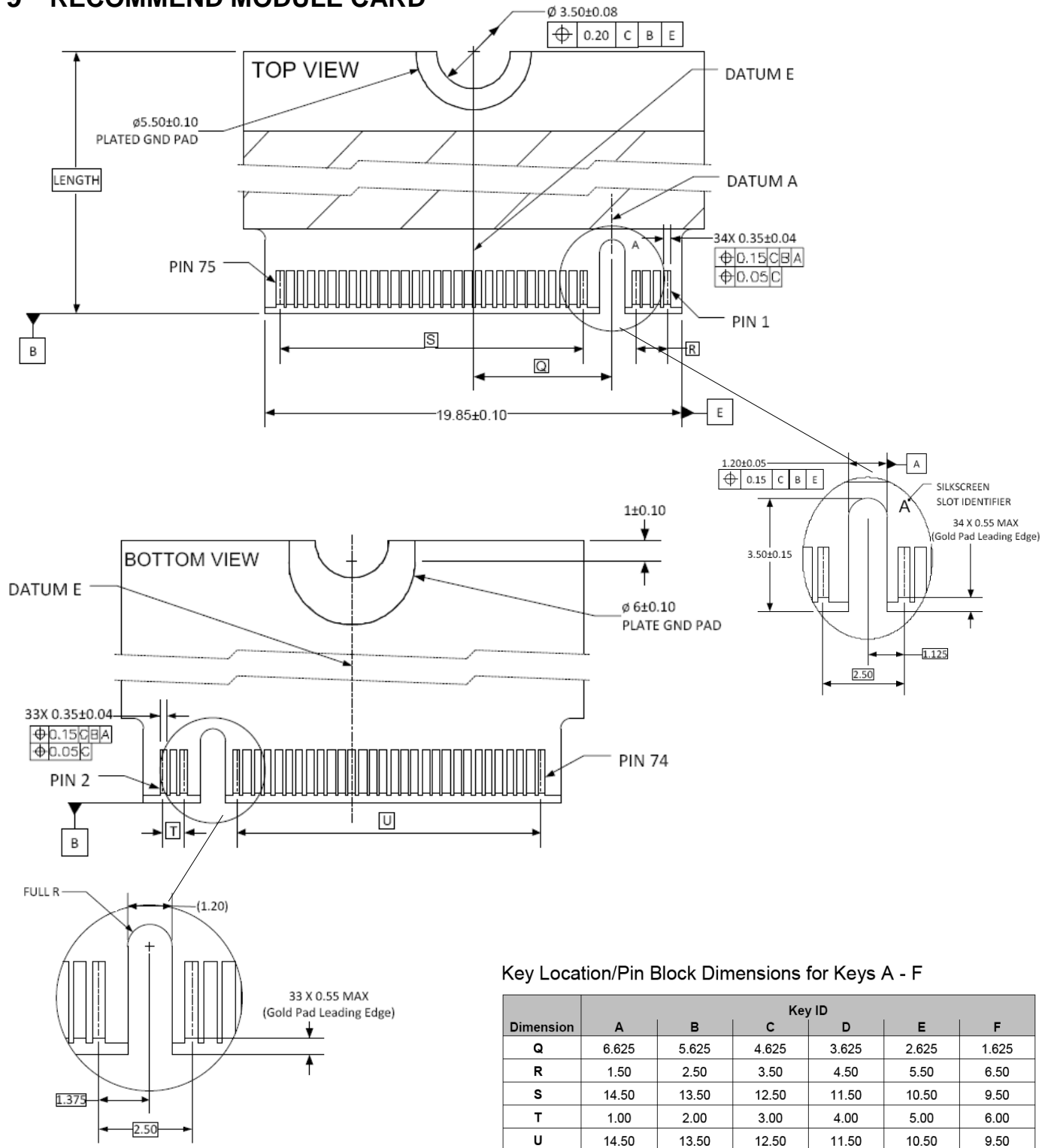
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9 RECOMMEND MODULE CARD



Key Location/Pin Block Dimensions for Keys A - F

Dimension	Key ID					
	A	B	C	D	E	F
Q	6.625	5.625	4.625	3.625	2.625	1.625
R	1.50	2.50	3.50	4.50	5.50	6.50
S	14.50	13.50	12.50	11.50	10.50	9.50
T	1.00	2.00	3.00	4.00	5.00	6.00
U	14.50	13.50	12.50	11.50	10.50	9.50

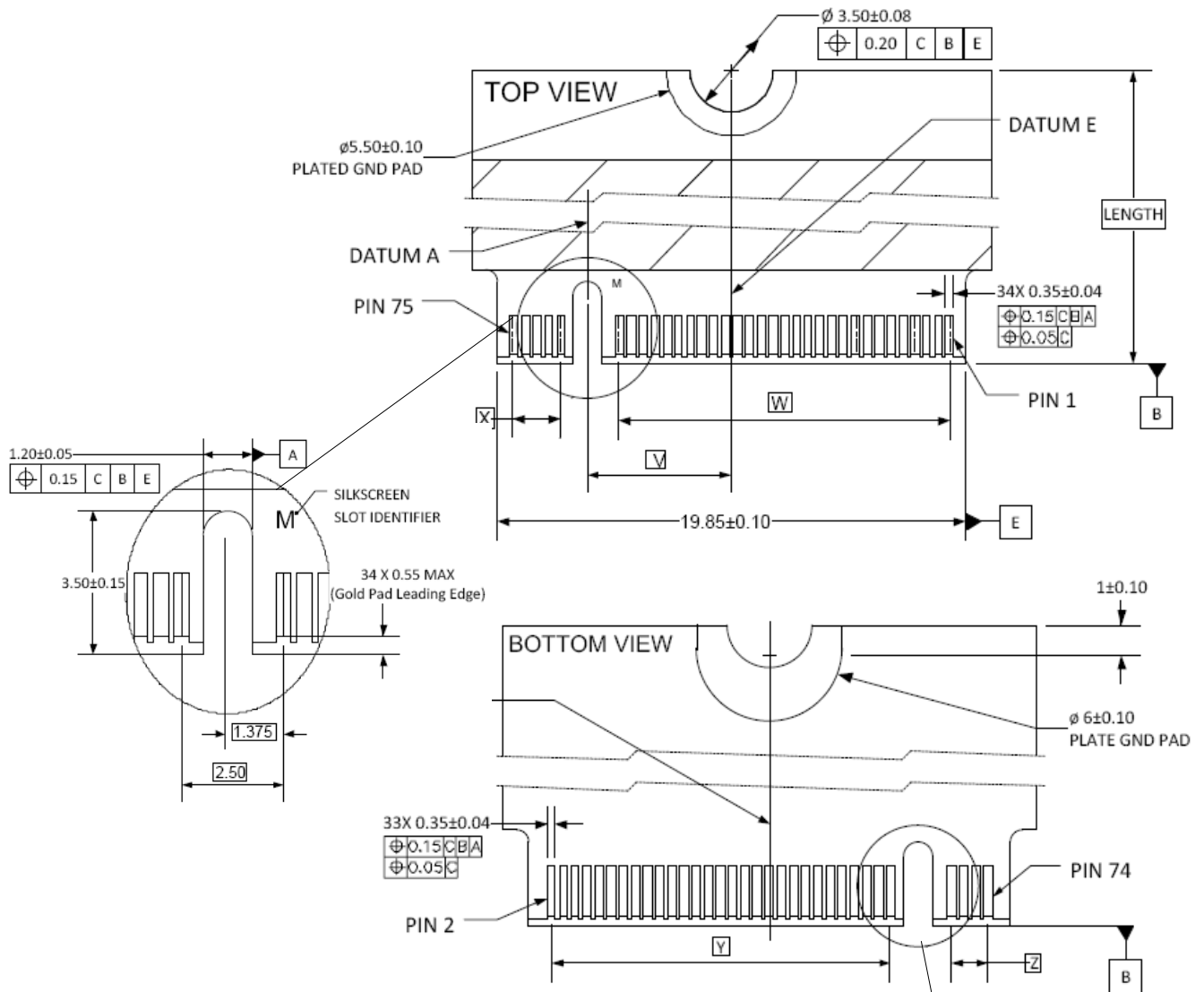
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Key Location/Pin Block Dimensions for Keys G - M

Dimension	Key ID					
	G	H	J	K	L	M
V	1.125	2.125	3.125	4.125	5.125	6.125
W	9.00	10.00	11.00	12.00	13.00	14.00
X	7.00	6.00	5.00	4.00	3.00	2.00
Y	9.00	10.00	11.00	12.00	13.00	14.00
Z	6.50	5.50	4.50	3.50	2.50	1.50

